RENESAS

H7N1004LD, H7N1004LS, H7N1004LM

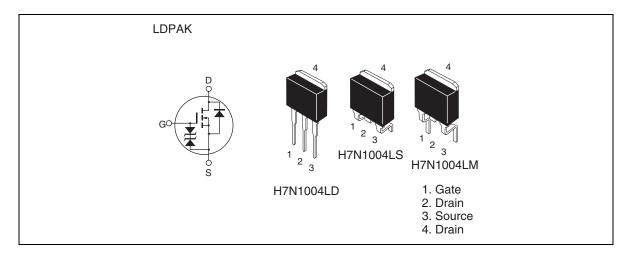
Silicon N-Channel MOSFET High-Speed Power Switching

> REJ03G0072-0600Z (Previous ADE-208-1552E(Z)) Rev.6.00 Aug.27.2003

Features

- Low on-resistance
- $R_{DS(on)} = 25 \text{ m}\Omega \text{ typ.}$
- Low drive current
- Available for 4.5 V gate drive

Outline





Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

| Item | Symbol | Value | Unit | |
|--|---|-------------|------|--|
| Drain to source voltage | V _{DSS} | 100 | V | |
| Gate to source voltage | V _{GSS} | ±20 | V | |
| Drain current | I _D | 30 | A | |
| Drain peak current | I _D (pulse) ^{Note1} | 100 | А | |
| Body-drain diode reverse drain current | I _{DR} | 30 | A | |
| Avalanche current | I _{AP} Note 3 | 15 | А | |
| Avalanche energy | E _{AR} ^{Note 3} | 22.5 | mJ | |
| Channel dissipation | Pch* Note 2 | 50 | W | |
| Channel temperature | Tch | 150 | °C | |
| Storage temperature | Tstg | -55 to +150 | ٥C | |

Notes: 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

2. Value at Tc = 25° C

3. Value at Tch = 25°C, Rg \ge 50 Ω

Electrical Characteristics

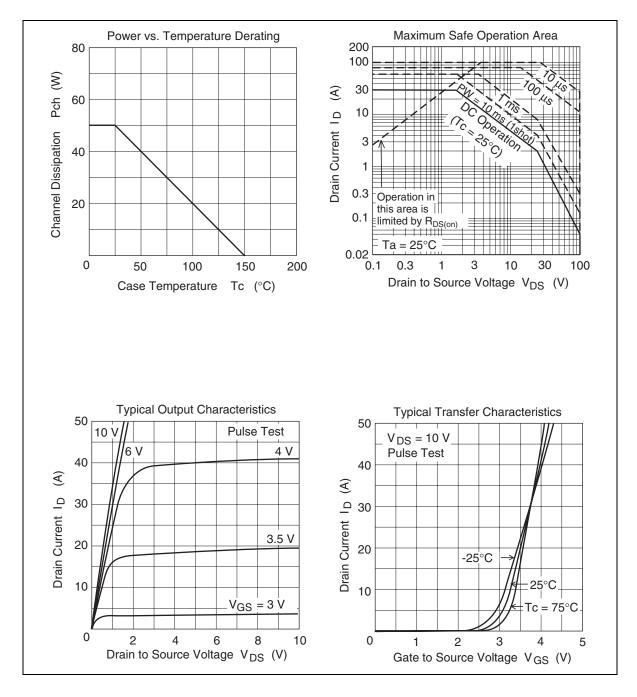
(Ta = 25°C)

| Item | Symbol | Min | Тур | Max | Unit | Test conditions |
|--|----------------------|-----|------|-----|------|---|
| Drain to source breakdown voltage | V _{(BR)DSS} | 100 | _ | _ | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| Gate to source breakdown voltage | V _{(BR)GSS} | ±20 | _ | | V | $I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | I _{GSS} | | _ | ±10 | μΑ | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | I _{DSS} | _ | _ | 10 | μΑ | $V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0$ |
| Gate to source cutoff voltage | $V_{\text{GS(off)}}$ | 1.5 | _ | 2.5 | V | $I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}^{\text{Note 1}}$ |
| Static drain to source on state | R _{DS(on)} | | 25 | 35 | mΩ | $I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 1}}$ |
| resistance | | _ | 30 | 45 | mΩ | I_D = 15 A, V_{GS} = 4.5 V ^{Note 1} |
| Forward transfer admittance | yfs | 22 | 37 | — | S | $I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 1}}$ |
| Input capacitance | Ciss | _ | 2800 | — | pF | V _{DS} = 10 V |
| Output capacitance | Coss | _ | 240 | _ | pF | $V_{GS} = 0$ |
| Reverse transfer capacitance | Crss | _ | 140 | — | pF | f = 1 MHz |
| Total gate charge | Qg | _ | 50 | _ | nC | V _{DD} = 50 V |
| Gate to source charge | Qgs | _ | 9 | — | nC | V _{GS} = 10 V |
| Gate to drain charge | Qgd | _ | 11 | — | nC | I _D = 30 A |
| Turn-on delay time | td(on) | _ | 23 | — | ns | V_{GS} = 10 V, I_{D} = 15 A |
| Rise time | tr | _ | 120 | — | ns | $R_L = 2 \Omega$ |
| Turn-off delay time | td(off) | _ | 70 | — | ns | Rg = 4.7 Ω |
| Fall time | tf | _ | 9.5 | _ | ns | _ |
| Body-drain diode forward voltage | V_{DF} | _ | 0.9 | _ | V | $I_F = 30 \text{ A}, V_{GS} = 0$ |
| Body-drain diode reverse recovery time | trr | — | 47 | _ | ns | $I_F = 30 \text{ A}, V_{GS} = 0$ diF/dt = 100 A/µs |
| Body-drain diode reverse recovery | | — | | — | | $I_F = 30 \text{ A}, V_{GS} = 0$ |

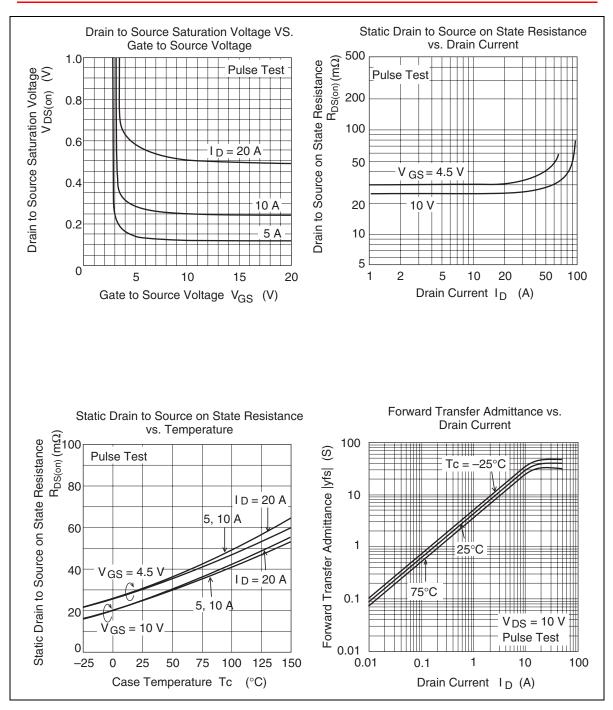
Notes: 1. Pulse test



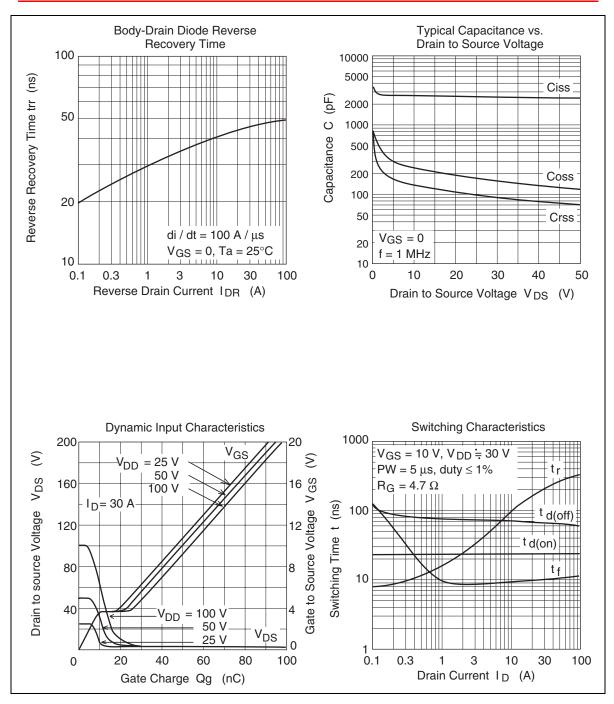
Main Characteristics



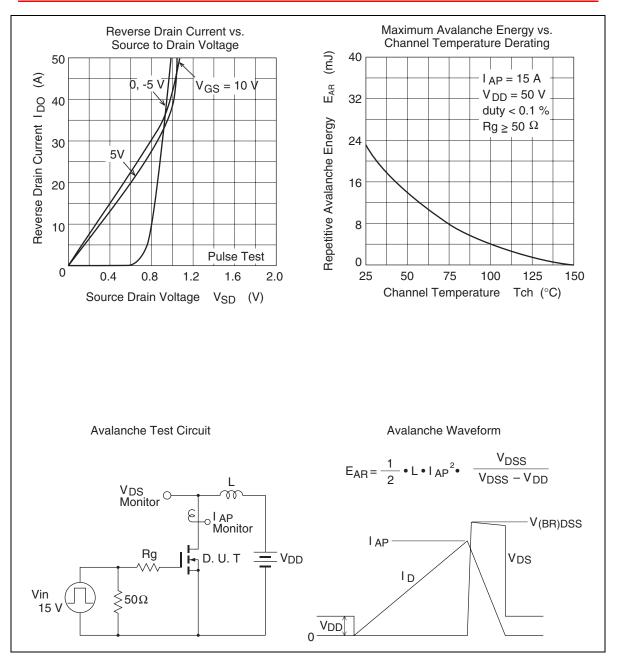




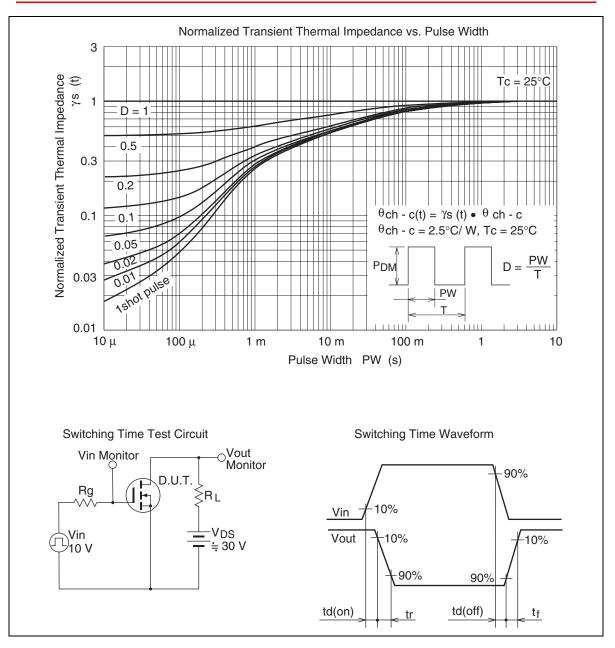






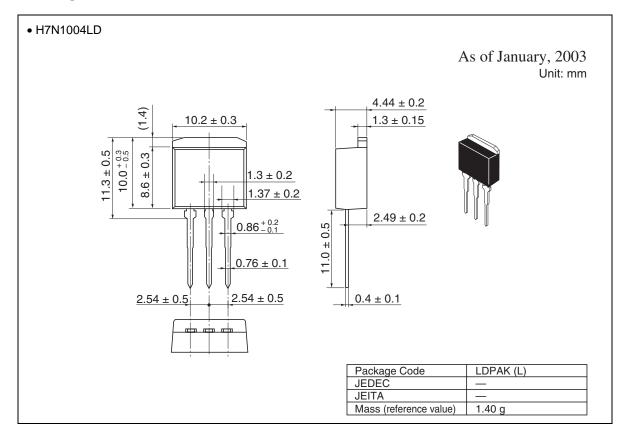




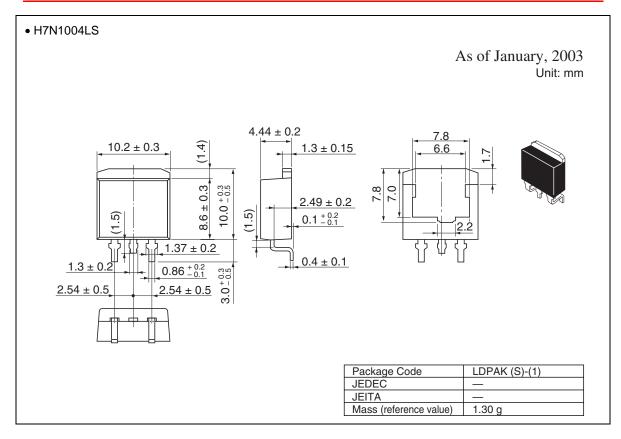




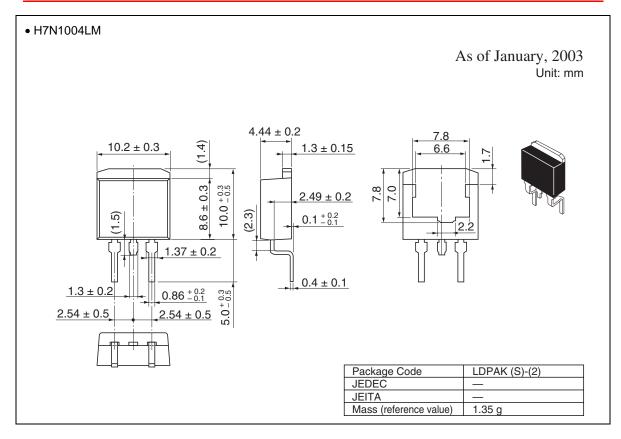
Package Dimensions













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